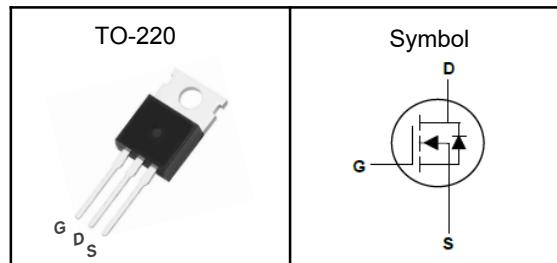


## 600V Super Junction Power MOSFET

### Features

- Low drain-source on-resistance:  $R_{DS(ON)}=0.06\Omega(\text{typ})$
- Easy to control gate switching
- Enhancement mode:  $V_{th} = 2.5 \text{ to } 4.5V$
- 100% avalanche tested
- RoHS compliant

### Pin Description



### Applications

- Switch Mode Power Supply (SMPS)
- TV power & LED Lighting Power
- AC to DC Converters
- Telecom

$V_{DSS}$	600	V
$R_{DS(ON)-\text{Typ}}$	60	$\text{m}\Omega$
$I_D$	43	A

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
$V_{DSS}$	Drain-Source Voltage	600	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$E_{AS}$	Single Pulse Avalanche Energy <sup>③</sup>	960	mJ
$I_{DM}^{①}$	300 $\mu\text{s}$ Pulse Drain Current Tested	129	A
$I_D$	Continuous Drain Current	43	A
$P_D$	Maximum Power Dissipation	236	W
$I_{AS}$	Avalanche Current	8	A
$dv/dt$	MOSFET $dv/dt$ ruggedness, $V_{DS} = 0 \dots 400V$	50	V/ns
	Reverse diode $dv/dt$ <sup>③</sup> $V_{DS}=0 \dots 400V$ , $I_{SD} \leq I_D$	15	

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case <sub>1</sub>	0.53	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## 600V Super Junction Power MOSFET

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=1\text{mA}$	600	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=600\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$V_{\text{GS(Th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=2.5\text{mA}$	2.5	---	4.5	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 30\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$	---	60	70	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=100\text{V}$ , Freq.=1.0MHz	---	3250	---	pF
$C_{\text{oss}}$	Output Capacitance		---	140	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	3.7	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DD}}=400\text{V}$ , $I_{\text{D}}=20\text{A}$ , $R_{\text{G}}=3\Omega$	---	23	---	nS
$T_r$	Turn-on Rise Time		---	15	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	88	---	
$T_f$	Turn-off Fall Time		---	10	---	
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DD}}=400\text{V}$ , $I_{\text{D}}=20\text{A}$	---	78	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	22	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	25	---	
$R_g$	Gate resistance	$f=1\text{ MHz}$ , open drain	---	1	---	$\Omega$
<b>Source-Drain Characteristics</b>						
$I_s$	Continuous Source Current		---	---	43	A
ISM	Maximum Pulsed Drain-Source Diode Forward Current		---	---	129	A
$V_{\text{SD}}$	Diode Forward Voltage	$I_s=20\text{A}$ , $V_{\text{GS}}=0\text{V}$	---	---	1.4	V
$t_{\text{rr}}$	Reverse recovery time	$I_s=20\text{A}$ , $V_{\text{GS}}=0\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$	---	420	---	ns
$Q_{\text{rr}}$	Reverse recovery charge		---	7.4	---	nC
$I_{\text{rrm}}$	Peak Reverse Recovery Current		---	3.5	---	A

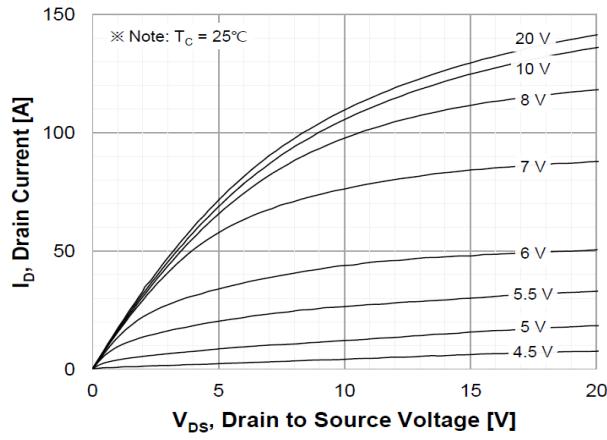
Note ④: Pulse test (pulse width $\leq 300\text{us}$ , duty cycle $\leq 2\%$ ).

Note ⑤: Guaranteed by design, not subject to production testing.

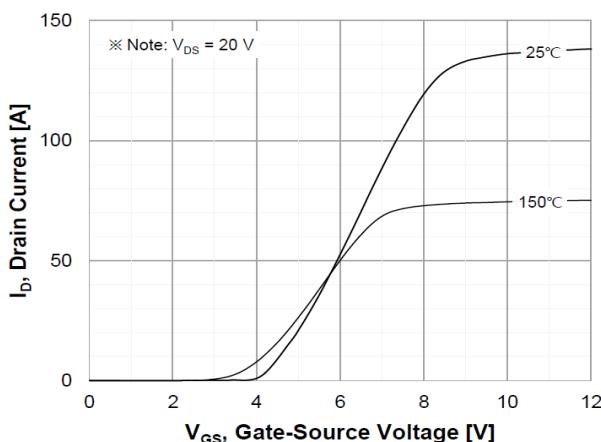
## 600V Super Junction Power MOSFET

### Typical Characteristics

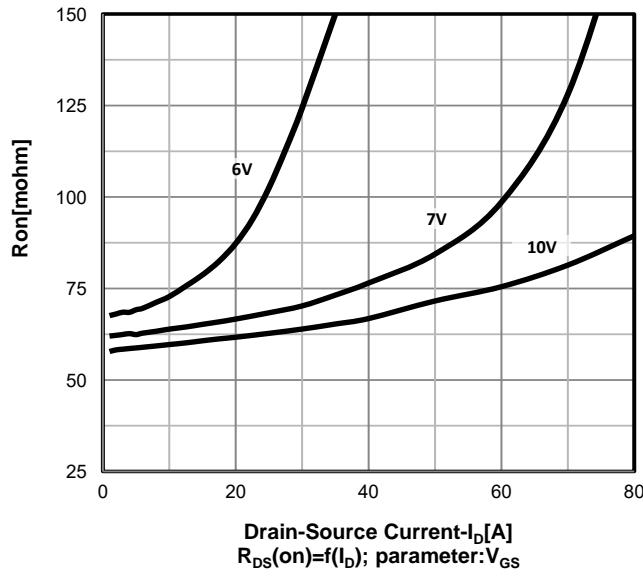
Typ. output characteristics  $T_j=25\text{ }^\circ\text{C}$



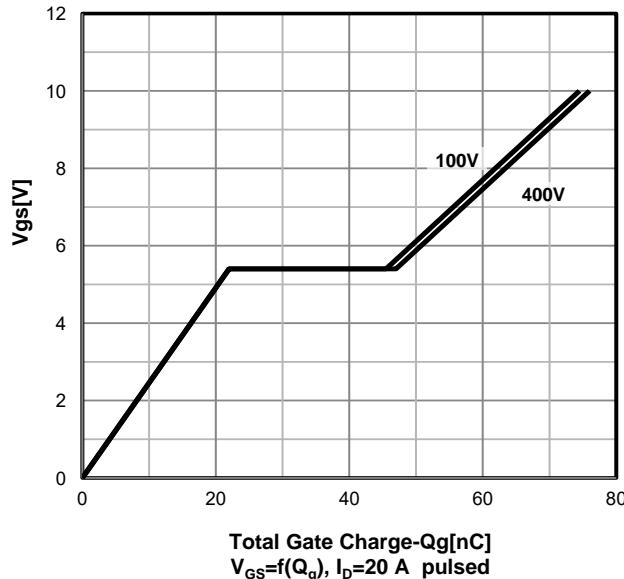
Transfer characteristics



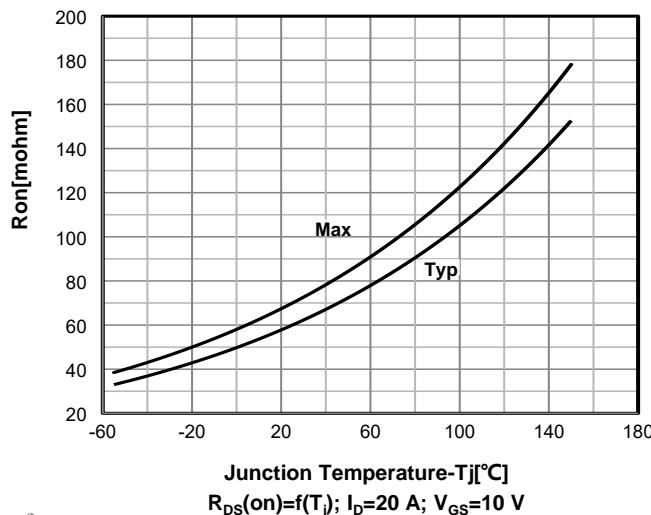
Typ. drain-source on-state resistance



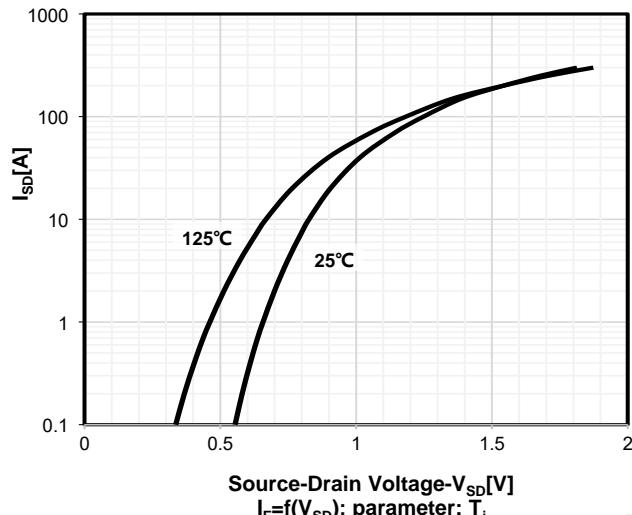
Typ. gate charge characteristics

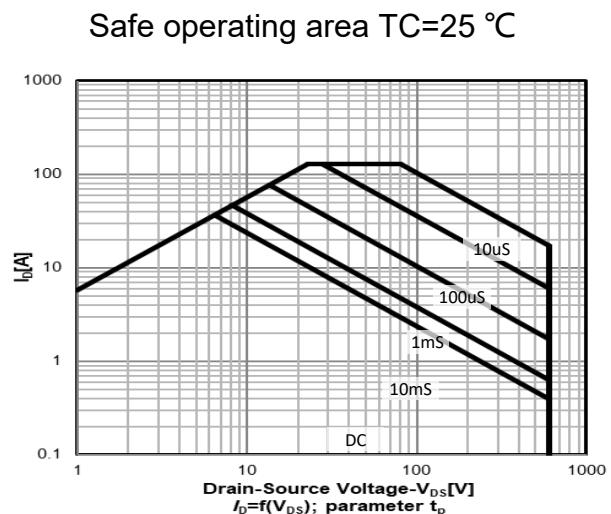
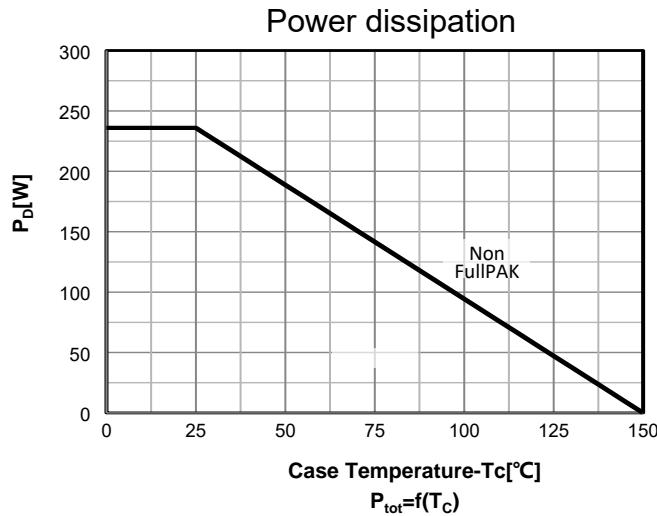
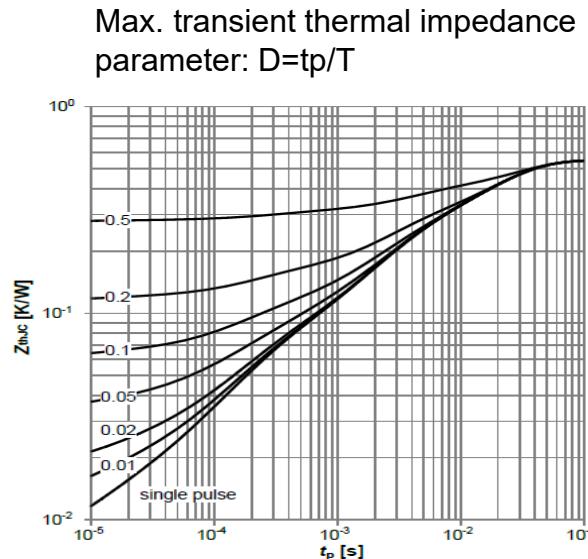
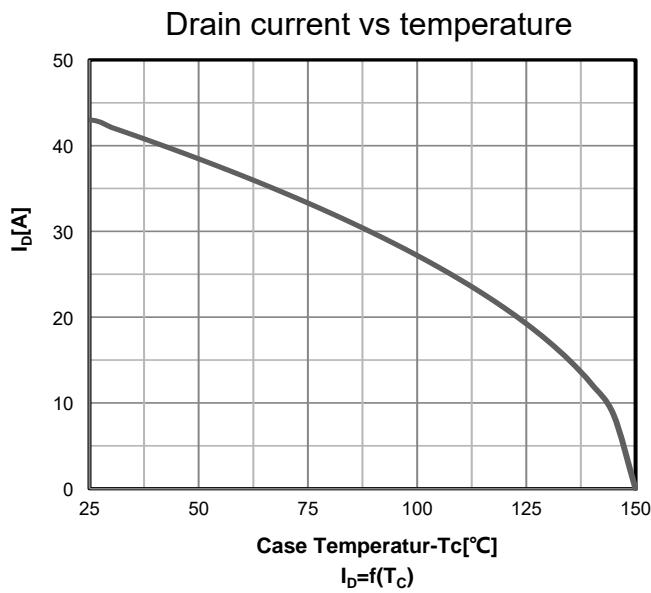
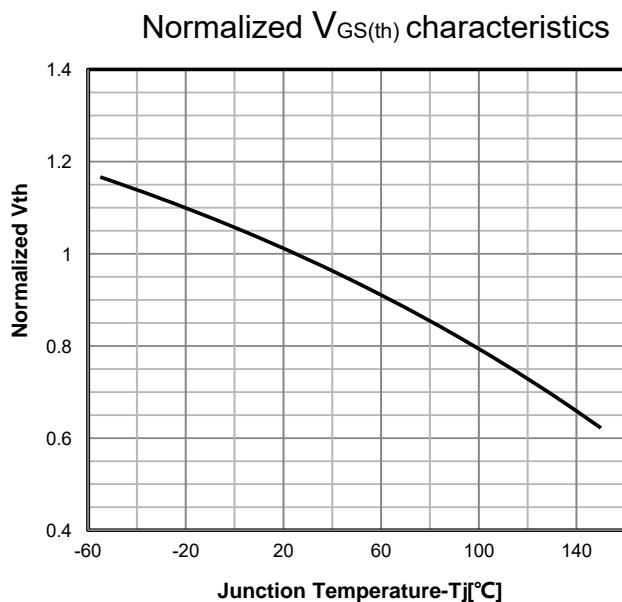
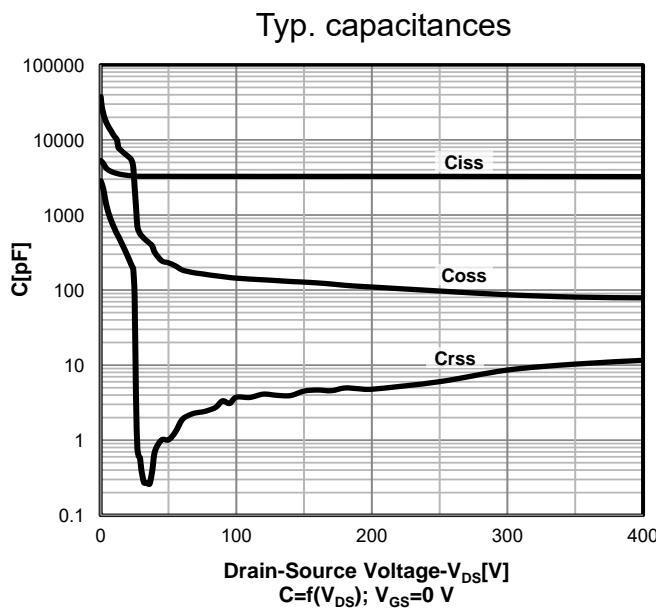


On-resistance vs temperature



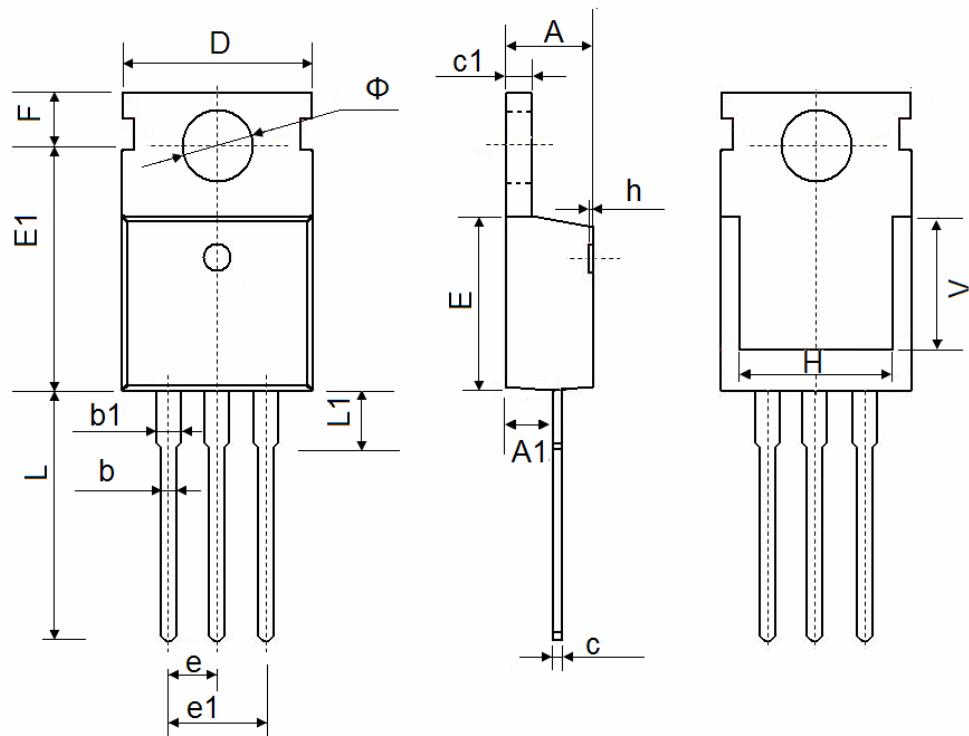
Forward characteristics of reverse diode



**600V Super Junction Power MOSFET**


## 600V Super Junction Power MOSFET

### TO-220 Package Outline Data



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.350	4.650
A1	2.250	2.550
b	0.710	0.910
b1	1.170	1.400
c	0.330	0.650
c1	1.200	1.400
D	9.910	10.250
E	8.9500	9.750
E1	12.650	12.950
e	2.540 TYP.	
e1	4.980	5.180
F	2.650	2.950
H	7.900	8.100
h	0.000	0.300
L	12.700	13.500
L1	2.850	3.250
V	7.500 REF.	
Φ	3.400	3.800